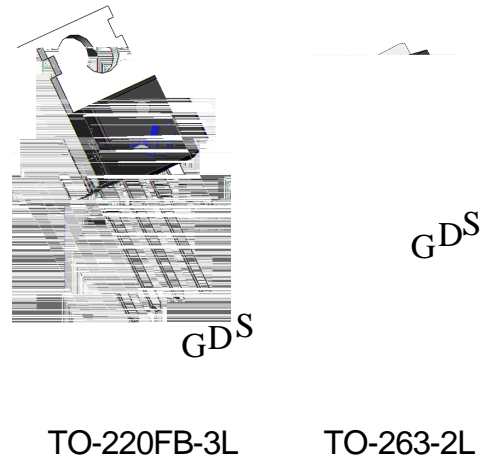


## N-Channel Enhancement Mode MOSFET

### Features

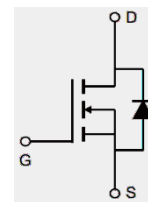
- 40V/250A  
 $R_{DS(ON)} = 2.3\text{ m}\Omega$  (typ.) @  $V_{GS} = 10\text{V}$
- 100% avalanche tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

### Pin Description



### Applications

- Switching Application
- Power Management for DC/DC



N-Channel MOSFET

### Ordering and Marking Information

 <b>P</b> <b>HY4504</b> YYXXXJWW G	 <b>B</b> <b>HY4504</b> YYXXXJWW G
Package Code P : TO-220FB-3L	B: TO-263-2L
Date Code YYXXX WW	Assembly Material G : Lead Free Device

Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines “Green” to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this product and/or to this document at any time without notice.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b> ( $T_C=25^\circ\text{C}$ Unless Otherwise Noted)			
$V_{DSS}$	Drain-Source Voltage	40	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	175	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ 250	A
<b>Mounted on Large Heat Sink</b>			
$I_{DM}$		$T_C=25^\circ\text{C}$ 805**	A
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$ 250	

$T_{C25}$  P T R R T - 38M - ns

1.8\*\*\*

**HY4504**

40

2.3 3.0

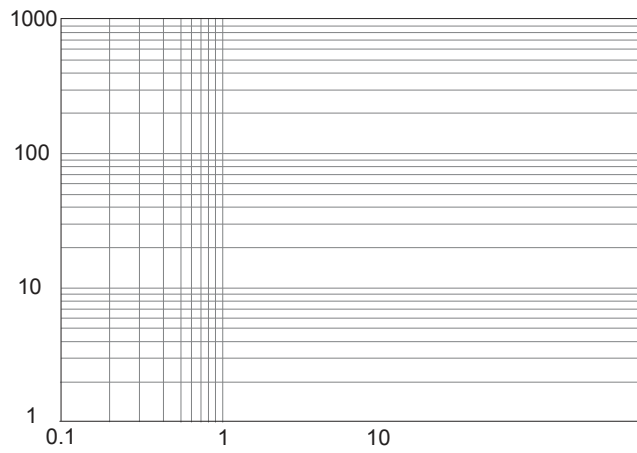
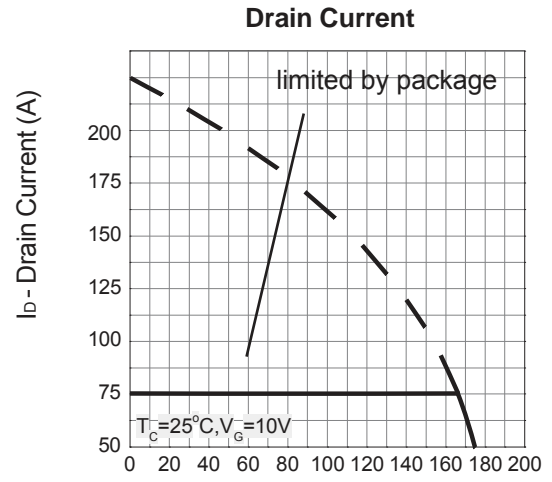
**Electrical Characteristics (Cont.)** ( $T_C = 25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	HY4504			Unit
			Min.	Typ.	Max.	
<b>Dynamic Characteristics</b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	-	1.0	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=25V,$ Frequency=1.0MHz	-	6985	-	pF
$C_{oss}$	Output Capacitance		-	1863	-	
$C_{rss}$	Reverse Transfer Capacitance		-	682	-	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=20V, R_G=6\ \Omega,$ $I_{DS}=125A, V_{GS}=10V,$	-	35	-	ns
$T_r$	Turn-on Rise Time		-	20	-	
$t_{d(OFF)}$	Turn-off Delay Time		-	45	-	
$T_f$	Turn-off Fall Time		-	62	-	
<b>Gate Charge Characteristics</b>						
$Q_g$	Total Gate Charge	$V_{DS}=32V, V_{GS}=10V,$ $I_{DS}=125A$	-	195	-	nC
$Q_{gs}$	Gate-Source Charge		-	30	-	
$Q_{gd}$	Gate-Drain Charge		-	80	-	

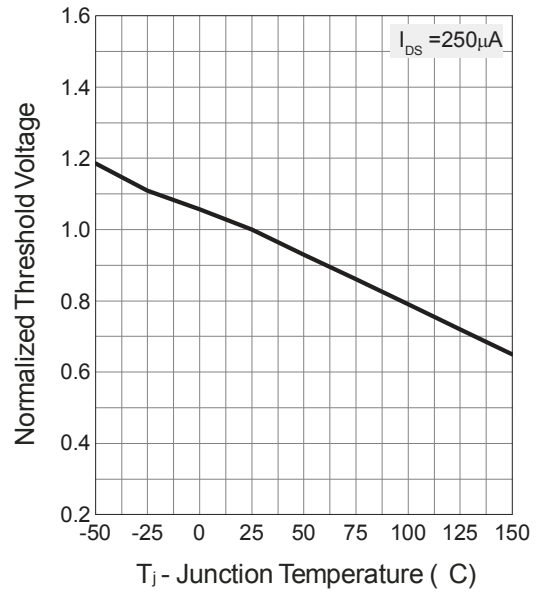
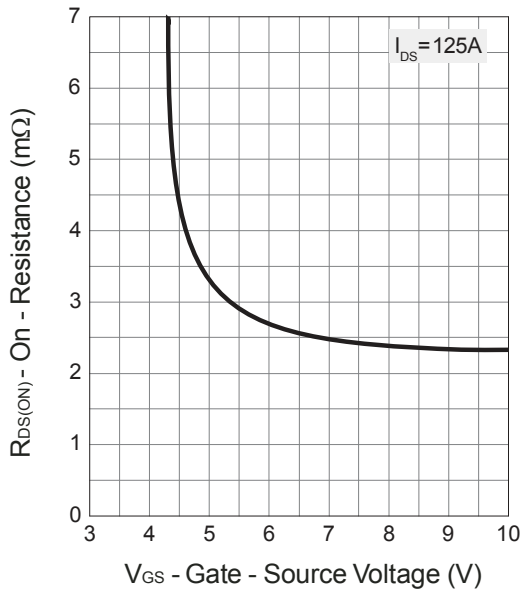
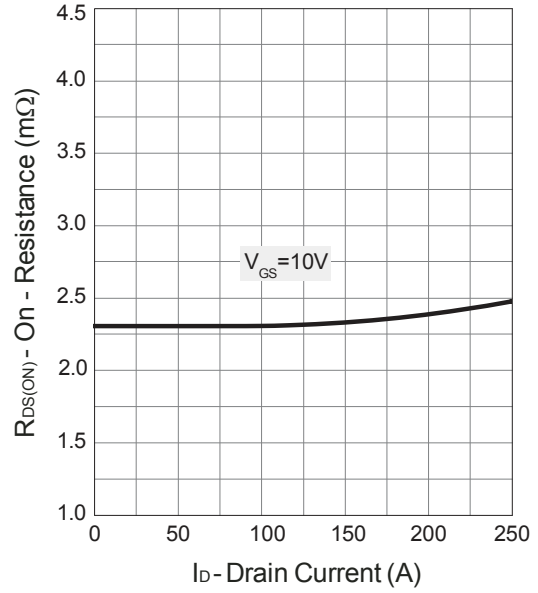
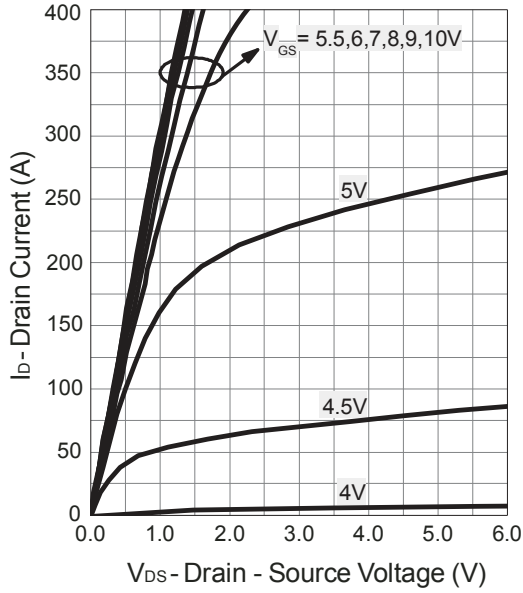
Note \* : Pulse test ; pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .

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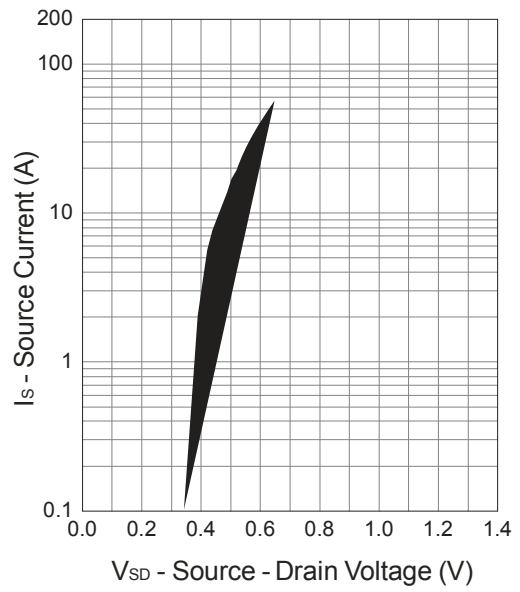
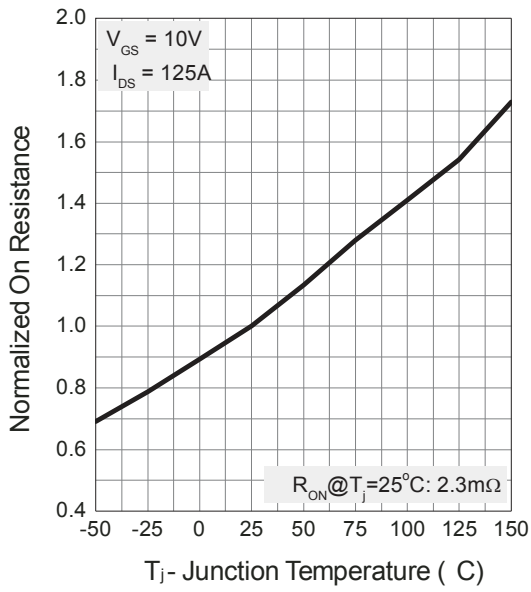
## Typical Operating Characteristics



Typical Operating Characteristics (Cont.)



## Typical Operating Characteristics (Cont.)

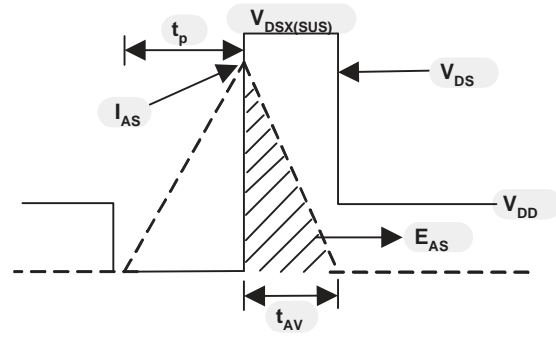
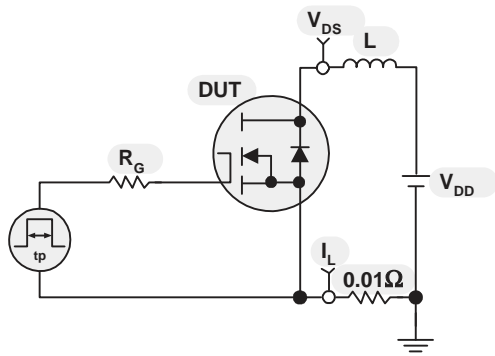


$V_{GS}$  - Gate-source Voltage (V)

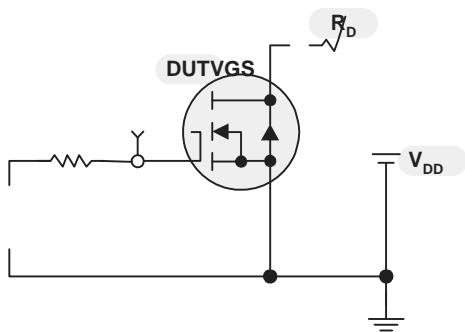
43

$Q_G$  - Gate Charge (nC)

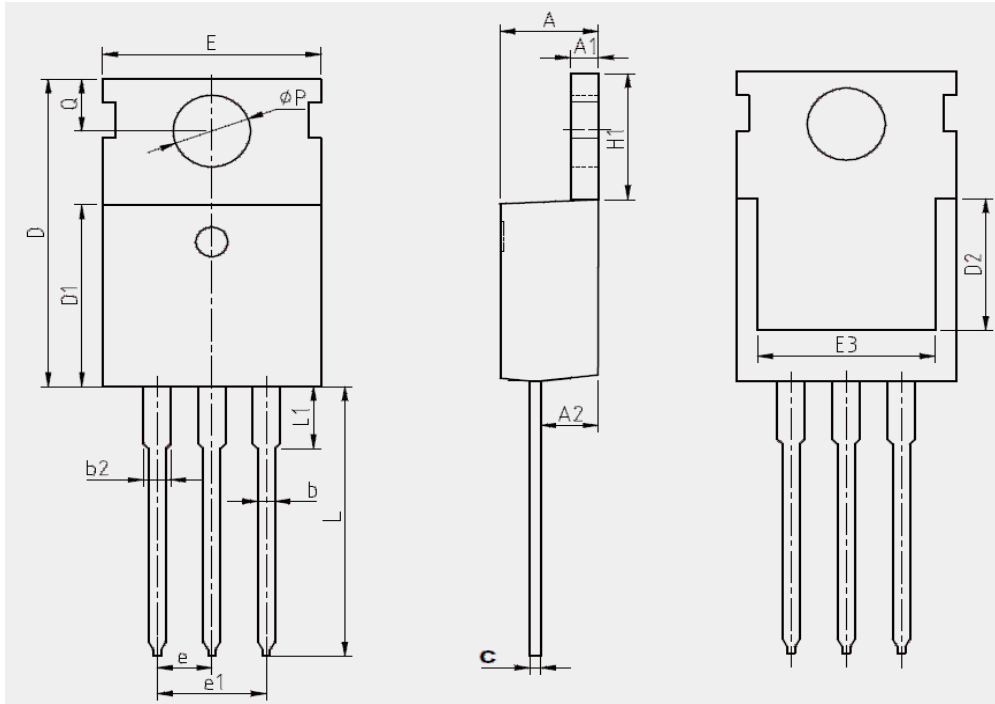
## Avalanche Test Circuit



## Avalanche Test Circuit



Package Information  
TO-220FB-3L

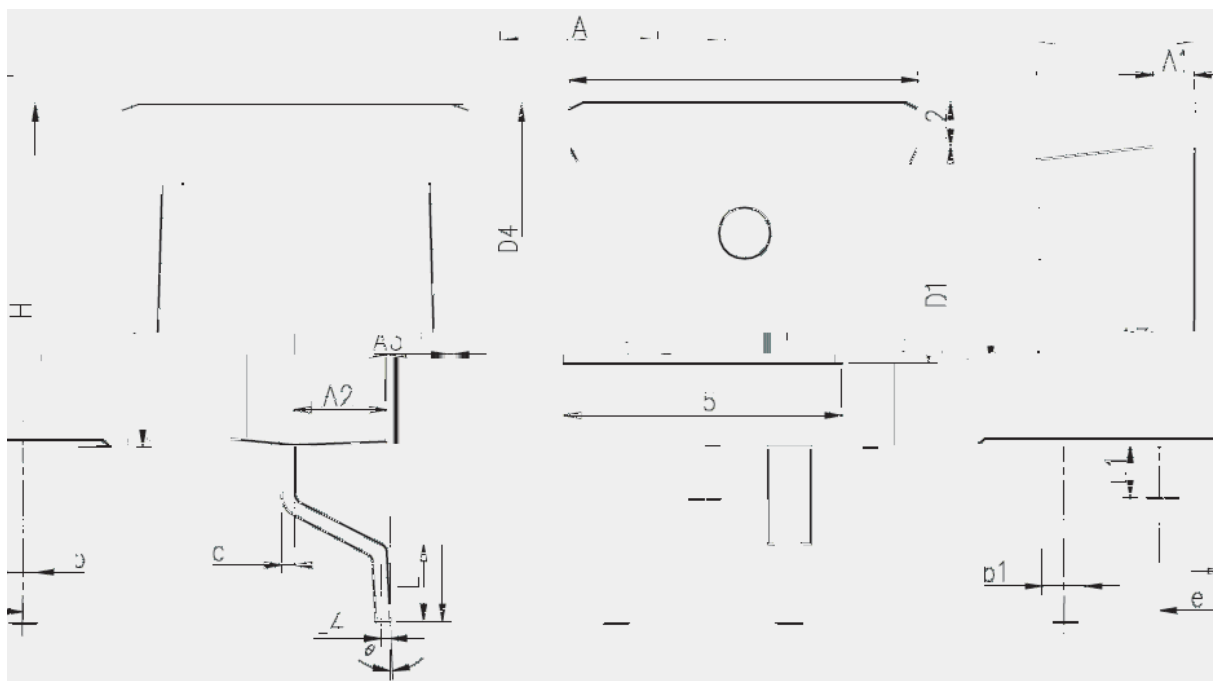


COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.77
A1	1.25	1.30	1.45
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
c	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
e	2.54 BSC		
e1	5.08 BSC		
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ϕP	3.40	3.60	3.80
Q	2.60	2.80	3.00



TO-263-2L



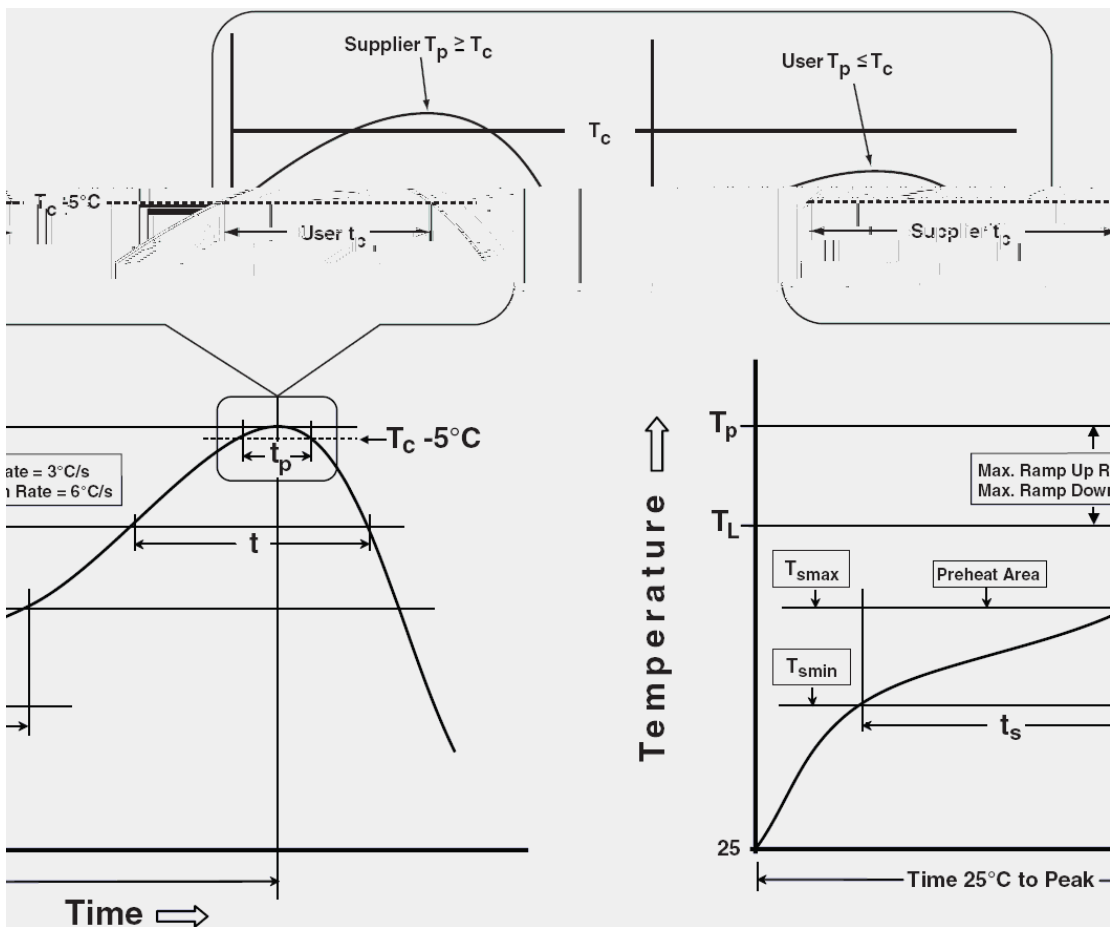
COMMON DIMENSIONS

SYMBOL	mm		
	MIN	N	MAX
A	4.37	4.57	4.77
A1	1.22	1.27	1.42
A2	2.49	2.69	2.89
A3	0	0.13	0.25
b	0.7	0.81	0.96
b1	1.17	1.27	1.47
c	0.3	0.38	0.53
D1	8.5	8.7	8.9
D4	6.6	-	-
E	9.86	10.16	10.36
E5	7.06	-	-
e	2.54 BSC		
H	14.7	15.1	15.5
H2	1.07	1.27	1.47
L	2	2.3	2.6
L1	1.4	1.55	1.7
L4	0.25 BSC		
θ	0°	5°	9°

**Devices Per Unit**

Package Type	Unit	Quantity
TO-220FB-3L	Tube	50
TO-263-2L	Tube	50

**Classification Profile**



**Classification Reflow Profiles**

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b> Temperature min ( $T_{smin}$ ) Temperature max ( $T_{smax}$ ) Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max.	3°C/second max.
Liquidous temperature ( $T_L$ ) Time at liquidous ( $t_L$ )	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body Temperature ( $T_p$ )*	See Classification Temp in table 1	See Classification Temp in table 2
Time ( $t_p$ )** within 5°C of the specified classification temperature ( $T_c$ )	20** seconds	30** seconds
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

**Reliability Test Program**

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

**Customer Service**

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Technical Support: Technology@hymexa.com

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